Vishay Siliconix

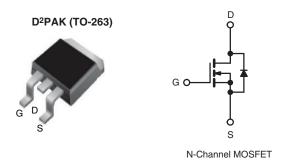
RoHS

COMPLIANT HALOGEN

FREE

E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.38		
Q _g max. (nC)	70			
Q _{gs} (nC)	9			
Q _{gd} (nC)	16			
Configuration	Single			



FEATURES

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	D ² PAK (TO-263)		
Lead (Pb)-free and Halogen-free	SiHB12N65E-GE3		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650	V	
Gate-Source Voltage			V_{GS}	± 30	\ \ \ \	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	I _D	12		
		T _C = 100 °C		8	Α	
Pulsed Drain Current ^a			I _{DM}	28		
Linear Derating Factor				1.4	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	226	mJ	
Maximum Power Dissipation			P _D	156	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		-11//-14	37	1//20	
Reverse Diode dV/dt ^d			dV/dt	28	- V/ns	
Soldering Recommendations (Peak Temperature) c	for 10 s			300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.8	G/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.78	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2	-	4	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	te-Source Leakage		V _{GS} = ± 30 V		_	± 1	μA
		V _{DS} = 650 V, V _{GS} = 0 V		-	-	1	μΑ
Zero Gate Voltage Drain Current	I_{DSS}		$V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		_	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.33	0.38	Ω
Forward Transconductance	9fs	V _{DS} = 30 V, I _D = 6 A		-	3.5	-	S
Dynamic		•					
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		-	1224	-	pF
Output Capacitance	Coss			-	65	-	
Reverse Transfer Capacitance	C _{rss}			-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	50	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	160	-	
Total Gate Charge	Qg			- 35	70		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 6 \text{ A}, V_{DS} = 520 \text{ V}$		-	9	-	nC
Gate-Drain Charge	Q _{gd}			-	16	-	1
Turn-On Delay Time	t _{d(on)}	V_{DD} = 520 V, I_{D} = 6 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		-	16	32	ns
Rise Time	t _r			-	19	38	
Turn-Off Delay Time	t _{d(off)}			-	35	70	
Fall Time	t _f			-	18	36	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.81	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12	•
Pulsed Diode Forward Current	I _{SM}			-	-	28	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	1.0	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 6 A, dl/dt = 100 A/µs, V _R = 25 V		-	309	618	ns
Reverse Recovery Charge	Q _{rr}			-	3.8	7.6	μC
Reverse Recovery Current	I _{RRM}				21	_	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

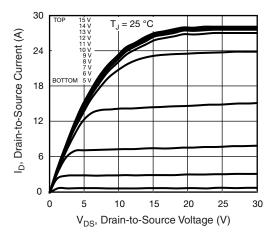


Fig. 1 - Typical Output Characteristics

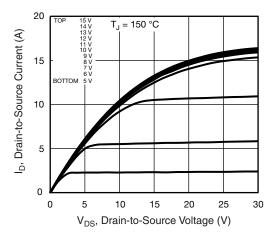


Fig. 2 - Typical Output Characteristics

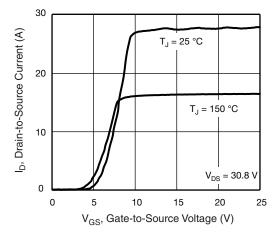


Fig. 3 - Typical Transfer Characteristics

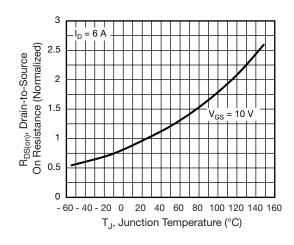


Fig. 4 - Normalized On-Resistance vs. Temperature

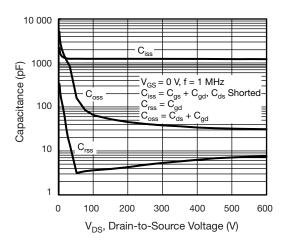


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

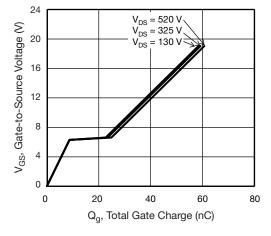


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



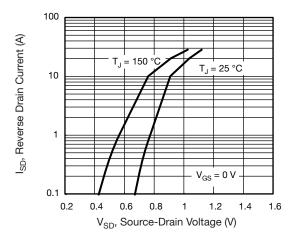


Fig. 7 - Typical Source-Drain Diode Forward Voltage

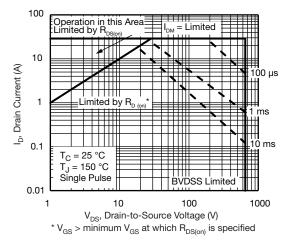


Fig. 8 - Maximum Safe Operating Area

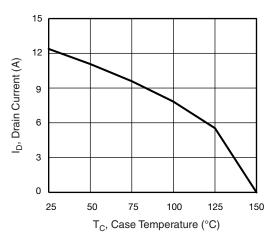


Fig. 9 - Maximum Drain Current vs. Case Temperature

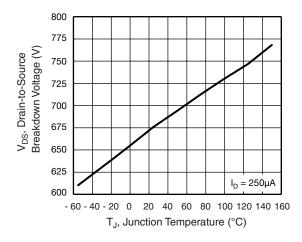


Fig. 10 - Temperature vs. Drain-to-Source Voltage

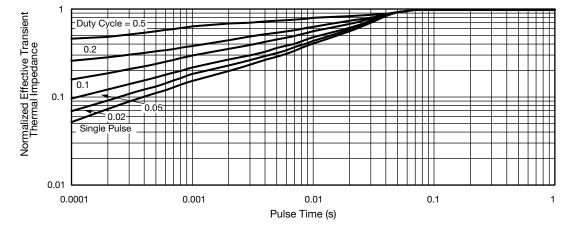


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



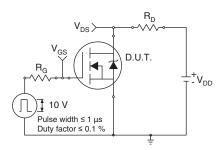


Fig. 12 - Switching Time Test Circuit

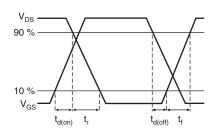


Fig. 13 - Switching Time Waveforms

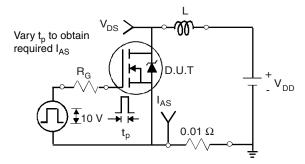


Fig. 14 - Unclamped Inductive Test Circuit

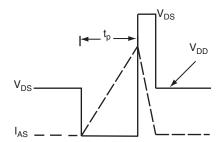


Fig. 15 - Unclamped Inductive Waveforms

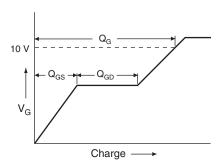


Fig. 16 - Basic Gate Charge Waveform

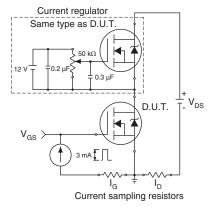
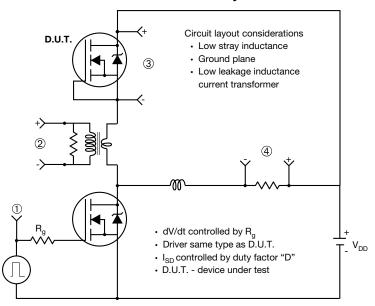


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



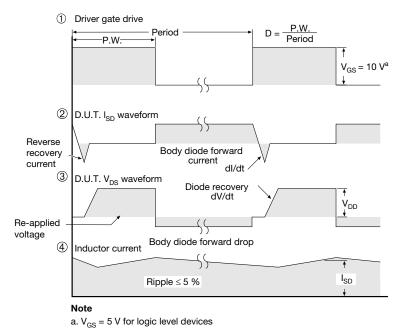


Fig. 18 - For N-Channel

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